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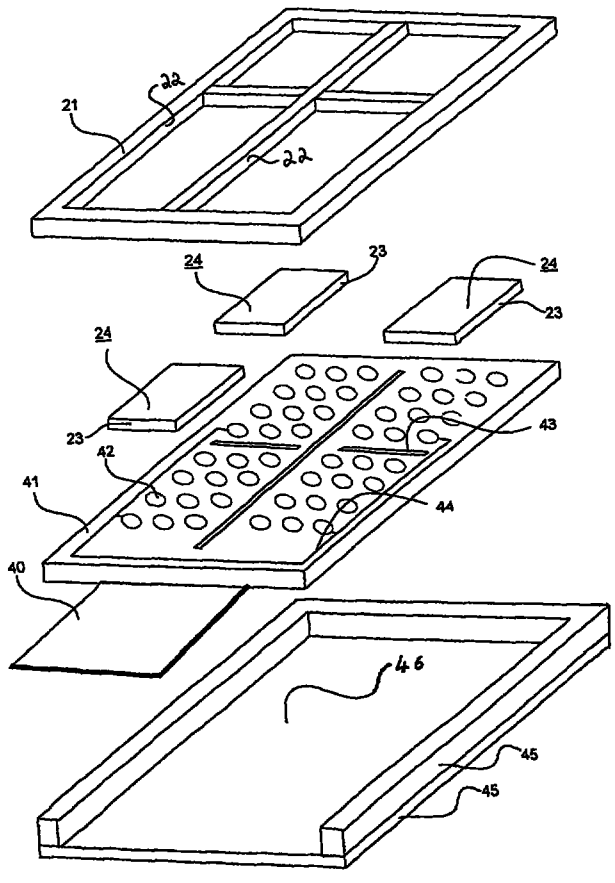
(54) Title: FINGERPRINT SENSING APPARATUS



(57) Abstract: Fingerprint sensing apparatus (10) includes a number of packaged semiconductor devices (11), each packaged semiconductor device (11) comprising a single fingerprint sensor die. Each die includes a sensing array surface (12). The devices (11) are arranged so that the sensing array surfaces (12) of the devices (11) define an apparatus sensing surface.

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